Interfacial Free Energy The free energy of a system containing an interface of area A and free energy & per unit area is: $G = G_0 + A X$ G_0 : free energy of the system assuming that all material has bulk property X: excess free energy arising because of the fact that some material lies also to interface.

Consider figure ; France bas a moveble bar with a force F per with length, must be applied to maintain the bar in possition. If force moves a small distance, the film area increase dA, the work done by this motion is FdA. The increase in free energy by this work is; JG = 8 JA + A J8 equating with FJA; => F=8+A dx



A liquid film on a wire frame.

In the case of a liquid film the surface energy is independent of the area of the interface, d8/dA = 0 => F=8 [the atoms in liq. can rearrang during strecking process] In solids, d8/dA = 0, but at temperatures Near the Melling point the atomic mobility is usually high enough for J8/dA = 0

Solid /Vapor Interface The origin of the surface free energy is that atoms in the layers nearest the surface are without some of their neighbours. On {1113 111 200 220 Surface in the Figure, 3 of the 12 neighbours are massing on the surface. If band strength is E, E/2 is lowered the interval energy of each dom. For pure metal & can be estimated from the heat of sublimetron Ls. If 1 mol of solid vaponzed 12 Na broken bands are formed. Therefore Ls = 12 Na E/2. Consequently the energy of a {III} surface is Esv = 0.25 Ls/Ne J/surface atom.

This result is approximate since 2nd nearest neighbours have been reproved. From the definition of Gibbs free energy, the surface free energy will be given by;

'PV' tern is ignored but surface entropy effects must be taken into account. Surface atoms will have more freedom of novevent. Also extra configurational entropy can be introduced because of a formation of surface vacancies. Experimental measured values for pure metals indicate that near the melting temperature the surface free energy averaged over many surface planes is since by;

Some relected values of Sov at the melting point are loded below. Note that metals with high melting tenperatures have high Lo values and high Sov

When the macroscopic surface plane has a high or irrational Shelf index the surface will appear as a stepped layer structure where each layer is a close-packed plane (see Figure) $\gamma_{sv}/mJ~m^{-2}$ $T_{\rm m}/^{\circ}{\rm C}$ Crystal A cryst-1 plane at on O to the 680 232 Sn 1080 660 Al 1120 961 close-packed plane will contain broken Ag 1390 1063 Au 1720 1084 Cu 2080 1536 bonds. δ-Fe 2280 1769 Pt For with leggth of interface; there will be 2650 3407 w (cos 0/a) (1/a) broken bends and En 101/a) (1/a) sintel/a broken bonds broken bonds from the atoms on the steps. UNIT LENGTH Again attributing E/2 energy to each broken bond; a

 $E_{sv} = (\cos\theta + \sin |\theta|) \frac{\varepsilon}{2^2}$

 $cos \theta/a \text{ broken bonds}$ The 'broken-bond' model for surface energy. This is plotted as a function of O in Figure. Note that the close-packed orientation (O=O) lives at the minimum in the energy plot. Similar arguments can be applied to any crystal structure for rotations about only axis draw any reasonably close-packed plane. If X is plotted vs. O similar Cusps are found. Low-index planes should be located at low-energy positions(wells).



A converient method for plotting the variation of Y with surface orientation in 3-D is to construct a surface about an origin such that the free energy of any plane is equal to the distance between the surface and the origin when measured along the normal to the place in question. This type of polar representation of & is known as 8-plot and has the useful property of being able to predict the equilibrium shope of an isolated single crystal. A Wulff plane y plot

Diamond (FCC)





Boundaries in Single-Phase Solids

The grains in a single-phase polycrystalline specimen are generally in many different orientations and many different types of grain boundary. The nature of any given boundary depends on the misorientation of the two adjoining grains and the orientation of the boundary plane relative to them. The lattices of any two grains can be made to coincide by rotating one of them through a suitable angle about a *single* axis, giving pure tilt boundaries and pure twist boundaries, as illustrated in Figure (a) and (b).

A tilt boundary occurs when the axis of rotation is parallel to the plane of the boundary (a), whereas a twist boundary is formed when the rotation axis is perpendicular to the boundary (b).



L ow-Angle and High-Angle Boundaries

These are symmetrical *low-angle tilt* and *low-angle twist* boundaries. The low angle tilt boundary is an array of parallel edge dislocations, whereas the twist boundary is a cross-grid of two sets of screw dislocations.

The energy of a low-angle grain boundary is simply the total energy of the dislocations within unit area of boundary. This depends on the spacing of the dislocations which, for the simple arrays in Figure, is given by

$$D = \frac{b}{\sin \theta} \simeq \frac{b}{\theta}.$$

where *b* is the Burgers vector of the dislocations and θ is the angular misorientation across the boundary.





At very small values of θ the dislocation spacing is very large and the grain boundary energy γ is approximately proportional to the density of dislocations in the boundary (1/D), i.e.

$\gamma \propto \theta$

However as θ increases the strain fields of the dislocations progressively cancel out so that γ increases at a decreasing rate as shown in previous Figure.

In general when θ exceeds 10-15⁰ the dislocation spacing is so small that the dislocation cores overlap and it is then impossible to physically identify the individual dislocations. At this stage the grain-boundary energy is almost independent of misorientation (see previous figure)



When $\theta > 10-15^{\circ}$ the boundary is known as a *random high-angle grain boundary*. The difference in structure between low-angle and high-angle grain boundaries is lucidly illustrated by the bubble-raft model in Figure below



High angle boundaries contain large areas of poor fit and have a relatively open structure. The bonds between the atoms are broken or highly distorted and consequently the boundary is associated with a relatively high energy. Measured high-angle grain boundary energies γ_b are often found to be roughly given by

$$\gamma_b \simeq \frac{1}{3} \gamma_{sv}$$

Some selected values for γb and γ_b / γ_{sv} are listed in Table

Crystal	γ _b /mJ m ⁻²	T/°C	$\gamma_b \gamma_{sv}$	
Sn	164	223	0.24	
Al	324	450	0.30	
Ag	375	950	0.33	
Au	378	1000	0.27	
Cu	625	925	0.36	
7-Fe	756	1350	0.40	
γ-Fe	468	1450	0.23	
δt	660	1300	0.29	
W	1080	2000	0.41	

Measured Grain Boundary Free Energies

Source: Values selected from compilation given in Interfacial Phenomena in Metals and Alloys, by L.E. Murr, Addison-Wesley, London, 1975.

Special High-Angle Grain Boundaries

Not all high-angle boundaries have an open disordered structure. There are some *special high-angle boundaries* which have significantly lower energies than the random boundaries. These boundaries only occur at particular misorientations and boundary planes which allow the two adjoining lattices to fit together with relatively little distortion of the interatomic bonds.

The simplest special high-angle grain boundary is the boundary between two twins. If the twin boundary is parallel to the twinning plane the atoms in the boundary fit perfectly into both grains. The result is a *coherent twin boundary* as illustrated in Fig



If the twin boundary does not lie exactly parallel to the twinning plane, Figure, the atoms do not fit perfectly into each grain and the boundary energy is much higher. This is known as an *incoherent twin boundary*. The energy of a twin boundary is therefore very sensitive to the orientation of the boundary plane. If γ is plotted as a function of the boundary orientation a sharp cusped minimum is obtained at the coherent boundary position as shown in Figure



Table lists some experimentally measured values of coherent and incoherent twins along with high-angle grain boundary energies for comparison

Crystal	Coherent Twin Boundary Energy	Incoherent Twin Boundary Energy	Grain Boundary Energy
Cu	21	498	623
Ag	8	126	377
Fe-Cr-Ni	19	209	835
(stainless			
steel type 304)			

Measured Boundary Free Energies for Crystals in Twin Relationships (Units mj m⁻²)

Source: Values selected from compilation given in Interfacial Phenomena in Metals and Alloys, by L.E. Murr, Addison-Wesley, London, 1975.

Equilibrium in Poly Crystalline Materials

Different grain-boundary energies affects the microstructure of a polycrystalline material. Figure shows the microstructure of an annealed austenitic stainless steel (fcc). The material contains high- and low-angle grain boundaries as well as coherent and incoherent twin boundaries.



Microstructure of an annealed crystal of austenitic stainless steel. (After P.G. Shewmon, Transformations in Metals, McGraw-Hill, New York, 1969.)

This microstructure is determined by how the different grain boundaries join together in space. When looking at two dimensional microstructures like this it is important to remember that in reality the grains fill three dimensions, and only one section of the three dimensional network of internal boundaries is apparent.

Note that two grains meet in a plane (a grain boundary), three grains meet in a line (a grain edge) and four grains meet at a point (a grain corner). Let us now consider the factors that control the grain shapes in a recrystallized polycrystal.

The first problem to be solved is why grain boundaries exist at all in annealed materials. The boundaries are all high-energy regions that increase the free energy of a polycrystal relative to a single crystal. Therefore a polycrystalline material is never a true equilibrium structure. However the grain boundaries in a polycrystal can adjust themselves during annealing to produce a *metastable* equilibrium at the grain boundary intersections The conditions for equilibrium at a grain-boundary junction can be obtained either by considering the total grain boundary energy associated with a particular configuration or, more simply, by considering the forces that each boundary exerts on the junction.

First consider a grain-boundary segment of unit width and length OP as shown in Fig



If the boundary is mobile then forces F_x and F_y must act at O and P to maintain the boundary in equilibrium.

Remember (F= γ), then $F_x = \gamma$. F_y can be calculated as follows: if P is moved a small distance *by* while O remains stationary, the work done will be $F_y \delta_y$. This must balance the increase in boundary energy caused by the change in orientation $\delta\theta$, i.e.

$$F_y \delta_y = l \frac{d\gamma}{d\theta} \delta\theta$$



This means that if the grain-boundary energy is dependent on the orientation of the boundary a force $d\gamma/d\theta$ must be applied to the ends of the boundary to prevent it rotating into a lower energy orientation.

 $d\gamma/d\theta$ is therefore known as a *torque term*. Since the segment OP must be supported by forces *Fx* and *Fy* the boundary exerts equal but opposite forces –*Fx* and –*Fy* on the ends of the segment which can be junctions with other grain boundaries.

If the boundary energy is independent of orientation the torque term is zero and the grain boundary behaves like a soap film. Under these conditions the requirement for metastable equilibrium at a junction between three grains, Figure, is that the boundary tensions $\gamma 1$, $\gamma 2$ and $\gamma 3$ must balance. In mathematical terms

$$\frac{\gamma_{23}}{\sin\theta_1} + \frac{\gamma_{13}}{\sin\theta_2} = \frac{\gamma_{12}}{\sin\theta_3}$$



One method of measuring grain-boundary energy is to anneal a specimen at a high temperature and then measure the angle at the intersection of the surface with the boundary (figure). If the solid-vapour energy (γ_{sv}) is the same for both grains, balancing the interfacial tensions gives

$$2\gamma_{sv}\cos\frac{\theta}{2} = \gamma_b$$



Exercise

Please draw the free energy-composition curves for the system in figure for all temperatures

